



Welcome to [E-XFL.COM](#)

### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Active
Number of LABs/CLBs	7911
Number of Logic Elements/Cells	101261
Total RAM Bits	4939776
Number of I/O	326
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc6slx100-3fg484c">https://www.e-xfl.com/product-detail/xilinx/xc6slx100-3fg484c</a>

## Quiescent Current

Typical values for quiescent supply current are specified at nominal voltage, 25°C junction temperatures ( $T_j$ ). Quiescent supply current is specified by speed grade for Spartan-6 devices. Xilinx recommends analyzing static power consumption using the XPOWER™ Estimator (XPE) tool (download at <http://www.xilinx.com/power>) for conditions other than those specified in Table 5.

Table 5: Typical Quiescent Supply Current

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
$I_{CCINTQ}$	Quiescent $V_{CCINT}$ supply current	LX4	4.0	4.0	4.0	2.4	mA
		LX9	4.0	4.0	4.0	2.4	mA
		LX16	6.0	6.0	6.0	4.0	mA
		LX25	11.0	11.0	11.0	6.6	mA
		LX25T	11.0	11.0	11.0	N/A	mA
		LX45	15.0	15.0	15.0	9.0	mA
		LX45T	15.0	15.0	15.0	N/A	mA
		LX75	29.0	29.0	29.0	17.4	mA
		LX75T	29.0	29.0	29.0	N/A	mA
		LX100	36.0	36.0	36.0	21.6	mA
		LX100T	36.0	36.0	36.0	N/A	mA
		LX150	51.0	51.0	51.0	31.0	mA
		LX150T	51.0	51.0	51.0	N/A	mA
$I_{CCOQ}$	Quiescent $V_{CCO}$ supply current	LX4	1.0	1.0	1.0	1.0	mA
		LX9	1.0	1.0	1.0	1.0	mA
		LX16	2.0	2.0	2.0	2.0	mA
		LX25	2.0	2.0	2.0	2.0	mA
		LX25T	2.0	2.0	2.0	N/A	mA
		LX45	3.0	3.0	3.0	3.0	mA
		LX45T	3.0	3.0	3.0	N/A	mA
		LX75	4.0	4.0	4.0	4.0	mA
		LX75T	4.0	4.0	4.0	N/A	mA
		LX100	5.0	5.0	5.0	5.0	mA
		LX100T	5.0	5.0	5.0	N/A	mA
		LX150	7.0	7.0	7.0	7.0	mA
		LX150T	7.0	7.0	7.0	N/A	mA

Table 10: Differential I/O Standard DC Input and Output Levels

I/O Standard	V <sub>ID</sub>		V <sub>ICM</sub>		V <sub>OD</sub>		V <sub>OCM</sub>		V <sub>OH</sub>	V <sub>OL</sub>
	mV, Min	mV, Max	V, Min	V, Max	mV, Min	mV, Max	V, Min	V, Max	V, Min	V, Max
LVDS_33 <sup>(2)(3)</sup>	100	600	0.3	2.35	247	454	1.125	1.375	—	—
LVDS_25 <sup>(2)(3)</sup>	100	600	0.3	2.35	247	454	1.125	1.375	—	—
BLVDS_25 <sup>(2)(3)</sup>	100	—	0.3	2.35	240	460	Typical 50% V <sub>CCO</sub>		—	—
MINI_LVDS_33	200	600	0.3	1.95	300	600	1.0	1.4	—	—
MINI_LVDS_25	200	600	0.3	1.95	300	600	1.0	1.4	—	—
LVPECL_33 <sup>(2)(3)</sup>	100	1000	0.3	2.8 <sup>(1)</sup>	Inputs only					
LVPECL_25 <sup>(2)(3)</sup>	100	1000	0.3	1.95	Inputs only					
RSDS_33 <sup>(2)(3)</sup>	100	—	0.3	1.5	100	400	1.0	1.4	—	—
RSDS_25 <sup>(2)(3)</sup>	100	—	0.3	1.5	100	400	1.0	1.4	—	—
TMDS_33	150	1200	2.7	3.23 <sup>(1)</sup>	400	800	V <sub>CCO</sub> – 0.405	V <sub>CCO</sub> – 0.190	—	—
PPDS_33 <sup>(2)(3)</sup>	100	400	0.2	2.3	100	400	0.5	1.4	—	—
PPDS_25 <sup>(2)(3)</sup>	100	400	0.2	2.3	100	400	0.5	1.4	—	—
DISPLAY_PORT	190	1260	0.3	2.35	—	—	Typical 50% V <sub>CCO</sub>		—	—
DIFF_MOBILE_DDR	100	—	0.78	1.02	—	—	—	—	90% V <sub>CCO</sub>	10% V <sub>CCO</sub>
DIFF_HSTL_I	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_II	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_III	100	—	0.68	0.9	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_I_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_II_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_HSTL_III_18	100	—	0.8	1.1	—	—	—	—	V <sub>CCO</sub> – 0.4	0.4
DIFF_SSTL3_I	100	—	1.0	1.9	—	—	—	—	V <sub>TT</sub> + 0.6	V <sub>TT</sub> – 0.6
DIFF_SSTL3_II	100	—	1.0	1.9	—	—	—	—	V <sub>TT</sub> + 0.8	V <sub>TT</sub> – 0.8
DIFF_SSTL2_I	100	—	1.0	1.5	—	—	—	—	V <sub>TT</sub> + 0.61	V <sub>TT</sub> – 0.61
DIFF_SSTL2_II	100	—	1.0	1.5	—	—	—	—	V <sub>TT</sub> + 0.81	V <sub>TT</sub> – 0.81
DIFF_SSTL18_I	100	—	0.7	1.1	—	—	—	—	V <sub>TT</sub> + 0.47	V <sub>TT</sub> – 0.47
DIFF_SSTL18_II	100	—	0.7	1.1	—	—	—	—	V <sub>TT</sub> + 0.6	V <sub>TT</sub> – 0.6
DIFF_SSTL15_II	100	—	0.55	0.95	—	—	—	—	V <sub>TT</sub> + 0.4	V <sub>TT</sub> – 0.4

**Notes:**

1. LVPECL\_33 and TMDS\_33 maximum V<sub>ICM</sub> is the lower of V (maximum) or V<sub>CCAUX</sub> – (V<sub>ID</sub>/2)
2. When V<sub>CCAUX</sub> = 3.3V, the DCD can be higher than 5% for V<sub>ICM</sub> < 0.7V when using these I/O standards: LVDS\_25, LVDS\_33, BLVDS\_25, LVPECL\_25, LVPECL\_33, RSDS\_25, RSDS\_33, PPDS\_25, and PPDS\_33.
3. The -1L devices require V<sub>CCAUX</sub> = 2.5V when using the LVDS\_25, LVDS\_33, BLVDS\_25, LVPECL\_25, RSDS\_25, RSDS\_33, PPDS\_25, and PPDS\_33 I/O standards on inputs. LVPECL\_33 is not supported in the -1L devices.

Table 14: GTP Transceiver Current Supply (per Lane)

Symbol	Description	Typ <sup>(1)</sup>	Max	Units
$I_{MGTAVCC}$	GTP transceiver internal analog supply current	40.4	Note 2	mA
$I_{MGTAVTTX}$	GTP transmitter termination supply current	27.4		mA
$I_{MGTAVTRX}$	GTP receiver termination supply current	13.6		mA
$I_{MGTAVCCPLL}$	GTP transmitter and receiver PLL supply current	28.7		mA
$R_{MGTRREF}$	Precision reference resistor for internal calibration termination	$50.0 \pm 1\%$ tolerance		$\Omega$

**Notes:**

1. Typical values are specified at nominal voltage, 25°C, with a 2.5 Gb/s line rate, with a shared PLL use mode.
2. Values for currents of other transceiver configurations and conditions can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

Table 15: GTP Transceiver Quiescent Supply Current (per Lane)<sup>(1)(2)(3)(4)</sup>

Symbol	Description	Typ <sup>(5)</sup>	Max	Units
$I_{MGTAVCCQ}$	Quiescent MGTAVCC supply current	1.7	Note 2	mA
$I_{MGTAVTTXQ}$	Quiescent MGTAVTTX supply current	0.1		mA
$I_{MGTAVTRXQ}$	Quiescent MGTAVTRX supply current	1.2		mA
$I_{MGTAVCCPLQ}$	Quiescent MGTAVCCPLL supply current	1.0		mA

**Notes:**

1. Device powered and unconfigured.
2. Currents for conditions other than values specified in this table can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.
3. GTP transceiver quiescent supply current for an entire device can be calculated by multiplying the values in this table by the number of available GTP transceivers.
4. Does not include power-up MGTAVTTRCAL supply current during device configuration.
5. Typical values are specified at nominal voltage, 25°C.

Table 23: GTP Transceiver Receiver Switching Characteristics

Symbol	Description			Min	Typ	Max	Units			
T <sub>RXELECIDLE</sub>	Time for RXELECIDLE to respond to loss or restoration of data			—	75	—	ns			
R <sub>XOOBVDPP</sub>	OOB detect threshold peak-to-peak			60	—	150	mV			
R <sub>XSST</sub>	Receiver spread-spectrum tracking <sup>(1)</sup>		Modulated @ 33 KHz		-5000	—	0	ppm		
R <sub>XRXL</sub>	Run length (CID)	Internal AC capacitor bypassed			—	—	150	UI		
R <sub>XPPMTOL</sub>	Data/REFCLK PPM offset tolerance	CDR 2 <sup>nd</sup> -order loop disabled			-200	—	200	ppm		
		CDR 2 <sup>nd</sup> -order loop enabled	PLL_RXDIVSEL_OUT = 1	-2000	—	2000	ppm			
			PLL_RXDIVSEL_OUT = 2	-2000	—	2000	ppm			
			PLL_RXDIVSEL_OUT = 4	-1000	—	1000	ppm			
<b>SJ Jitter Tolerance<sup>(2)</sup></b>										
JT_SJ <sub>3.125</sub>	Sinusoidal Jitter <sup>(3)</sup>		3.125 Gb/s		0.4	—	—	UI		
JT_SJ <sub>2.5</sub>	Sinusoidal Jitter <sup>(3)</sup>		2.5 Gb/s		0.4	—	—	UI		
JT_SJ <sub>1.62</sub>	Sinusoidal Jitter <sup>(3)</sup>		1.62 Gb/s		0.5	—	—	UI		
JT_SJ <sub>1.25</sub>	Sinusoidal Jitter <sup>(3)</sup>		1.25 Gb/s		0.5	—	—	UI		
JT_SJ <sub>614</sub>	Sinusoidal Jitter <sup>(3)</sup>		614 Mb/s		0.5	—	—	UI		
<b>SJ Jitter Tolerance with Stressed Eye<sup>(2)(5)</sup></b>										
JT_TJSE <sub>3.125</sub>	Total Jitter with stressed eye <sup>(4)</sup>	3.125 Gb/s		0.65	—	—	UI			
JT_SJSE <sub>3.125</sub>	Sinusoidal Jitter with stressed eye	3.125 Gb/s		0.1	—	—	UI			
JT_TJSE <sub>2.7</sub>	Total Jitter with stressed eye <sup>(4)</sup>	2.7 Gb/s		0.65	—	—	UI			
JT_SJSE <sub>2.7</sub>	Sinusoidal Jitter with stressed eye	2.7 Gb/s		0.1	—	—	UI			

**Notes:**

1. Using PLL\_RXDIVSEL\_OUT = 1, 2, and 4.
2. All jitter values are based on a Bit Error Ratio of  $1e^{-12}$ .
3. Using 80 MHz sinusoidal jitter only in the absence of deterministic and random jitter.
4. Composed of 0.37 UI DJ in the form of ISI and 0.18 UI RJ.
5. Measured using PRBS7 data pattern.

## Endpoint Block for PCI Express Designs Switching Characteristics

The Endpoint block for PCI Express is available in the Spartan-6 LXT devices. Consult the [Spartan-6 FPGA Integrated Endpoint Block for PCI Express](#) for further information.

Table 24: Maximum Performance for PCI Express Designs

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
F <sub>PCIEUSER</sub>	User clock maximum frequency	62.5	62.5	62.5	N/A	MHz

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units	
	Speed Grade				Speed Grade				Speed Grade					
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>		
LVCMOS33, Fast, 8 mA	1.34	1.46	1.59	1.82	2.07	2.21	2.41	3.03	2.07	2.21	2.41	3.03	ns	
LVCMOS33, Fast, 12 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS33, Fast, 16 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS33, Fast, 24 mA	1.34	1.46	1.59	1.82	1.65	1.79	1.99	2.62	1.65	1.79	1.99	2.62	ns	
LVCMOS25, QUIETIO, 2 mA	0.82	0.94	1.07	1.31	4.81	4.95	5.15	5.79	4.81	4.95	5.15	5.79	ns	
LVCMOS25, QUIETIO, 4 mA	0.82	0.94	1.07	1.31	3.70	3.84	4.04	4.66	3.70	3.84	4.04	4.66	ns	
LVCMOS25, QUIETIO, 6 mA	0.82	0.94	1.07	1.31	3.46	3.60	3.80	4.38	3.46	3.60	3.80	4.38	ns	
LVCMOS25, QUIETIO, 8 mA	0.82	0.94	1.07	1.31	3.20	3.34	3.54	4.12	3.20	3.34	3.54	4.12	ns	
LVCMOS25, QUIETIO, 12 mA	0.82	0.94	1.07	1.31	2.83	2.97	3.17	3.75	2.83	2.97	3.17	3.75	ns	
LVCMOS25, QUIETIO, 16 mA	0.82	0.94	1.07	1.31	2.64	2.78	2.98	3.64	2.64	2.78	2.98	3.64	ns	
LVCMOS25, QUIETIO, 24 mA	0.82	0.94	1.07	1.31	2.45	2.59	2.79	3.42	2.45	2.59	2.79	3.42	ns	
LVCMOS25, Slow, 2 mA	0.82	0.94	1.07	1.31	3.78	3.92	4.12	4.76	3.78	3.92	4.12	4.76	ns	
LVCMOS25, Slow, 4 mA	0.82	0.94	1.07	1.31	2.79	2.93	3.13	3.73	2.79	2.93	3.13	3.73	ns	
LVCMOS25, Slow, 6 mA	0.82	0.94	1.07	1.31	2.73	2.87	3.07	3.66	2.73	2.87	3.07	3.66	ns	
LVCMOS25, Slow, 8 mA	0.82	0.94	1.07	1.31	2.48	2.62	2.82	3.42	2.48	2.62	2.82	3.42	ns	
LVCMOS25, Slow, 12 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns	
LVCMOS25, Slow, 16 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.95	2.01	2.15	2.35	2.95	ns	
LVCMOS25, Slow, 24 mA	0.82	0.94	1.07	1.31	2.01	2.15	2.35	2.94	2.01	2.15	2.35	2.94	ns	
LVCMOS25, Fast, 2 mA	0.82	0.94	1.07	1.31	3.35	3.49	3.69	4.31	3.35	3.49	3.69	4.31	ns	
LVCMOS25, Fast, 4 mA	0.82	0.94	1.07	1.31	2.25	2.39	2.59	3.22	2.25	2.39	2.59	3.22	ns	
LVCMOS25, Fast, 6 mA	0.82	0.94	1.07	1.31	2.09	2.23	2.43	3.05	2.09	2.23	2.43	3.05	ns	
LVCMOS25, Fast, 8 mA	0.82	0.94	1.07	1.31	2.02	2.16	2.36	2.98	2.02	2.16	2.36	2.98	ns	
LVCMOS25, Fast, 12 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS25, Fast, 16 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS25, Fast, 24 mA	0.82	0.94	1.07	1.31	1.56	1.70	1.90	2.52	1.56	1.70	1.90	2.52	ns	
LVCMOS18, QUIETIO, 2 mA	1.18	1.30	1.43	2.04	5.92	6.06	6.26	6.80	5.92	6.06	6.26	6.80	ns	
LVCMOS18, QUIETIO, 4 mA	1.18	1.30	1.43	2.04	4.74	4.88	5.08	5.63	4.74	4.88	5.08	5.63	ns	
LVCMOS18, QUIETIO, 6 mA	1.18	1.30	1.43	2.04	4.05	4.19	4.39	4.96	4.05	4.19	4.39	4.96	ns	
LVCMOS18, QUIETIO, 8 mA	1.18	1.30	1.43	2.04	3.71	3.85	4.05	4.63	3.71	3.85	4.05	4.63	ns	
LVCMOS18, QUIETIO, 12 mA	1.18	1.30	1.43	2.04	3.35	3.49	3.69	4.27	3.35	3.49	3.69	4.27	ns	
LVCMOS18, QUIETIO, 16 mA	1.18	1.30	1.43	2.04	3.20	3.34	3.54	4.14	3.20	3.34	3.54	4.14	ns	
LVCMOS18, QUIETIO, 24 mA	1.18	1.30	1.43	2.04	2.96	3.10	3.30	3.98	2.96	3.10	3.30	3.98	ns	
LVCMOS18, Slow, 2 mA	1.18	1.30	1.43	2.04	4.62	4.76	4.96	5.54	4.62	4.76	4.96	5.54	ns	
LVCMOS18, Slow, 4 mA	1.18	1.30	1.43	2.04	3.69	3.83	4.03	4.60	3.69	3.83	4.03	4.60	ns	
LVCMOS18, Slow, 6 mA	1.18	1.30	1.43	2.04	3.00	3.14	3.34	3.94	3.00	3.14	3.34	3.94	ns	
LVCMOS18, Slow, 8 mA	1.18	1.30	1.43	2.04	2.19	2.33	2.53	3.17	2.19	2.33	2.53	3.17	ns	
LVCMOS18, Slow, 12 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns	
LVCMOS18, Slow, 16 mA	1.18	1.30	1.43	2.04	1.99	2.13	2.33	2.95	1.99	2.13	2.33	2.95	ns	

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOP1</sub>		T <sub>IOOP</sub>		T <sub>IOTP</sub>		Units	
	Speed Grade		Speed Grade		Speed Grade			
	-3	-2	-3	-2	-3	-2		
LVCMOS18, QUIETIO, 16 mA	1.25	1.43	3.34	3.54	3.34	3.54	ns	
LVCMOS18, QUIETIO, 24 mA	1.25	1.43	3.18	3.38	3.18	3.38	ns	
LVCMOS18, Slow, 2 mA	1.25	1.43	4.79	4.99	4.79	4.99	ns	
LVCMOS18, Slow, 4 mA	1.25	1.43	3.84	4.04	3.84	4.04	ns	
LVCMOS18, Slow, 6 mA	1.25	1.43	3.17	3.37	3.17	3.37	ns	
LVCMOS18, Slow, 8 mA	1.25	1.43	2.37	2.57	2.37	2.57	ns	
LVCMOS18, Slow, 12 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns	
LVCMOS18, Slow, 16 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns	
LVCMOS18, Slow, 24 mA	1.25	1.43	2.13	2.33	2.13	2.33	ns	
LVCMOS18, Fast, 2 mA	1.25	1.43	3.78	3.98	3.78	3.98	ns	
LVCMOS18, Fast, 4 mA	1.25	1.43	2.54	2.74	2.54	2.74	ns	
LVCMOS18, Fast, 6 mA	1.25	1.43	2.02	2.22	2.02	2.22	ns	
LVCMOS18, Fast, 8 mA	1.25	1.43	1.95	2.15	1.95	2.15	ns	
LVCMOS18, Fast, 12 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns	
LVCMOS18, Fast, 16 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns	
LVCMOS18, Fast, 24 mA	1.25	1.43	1.85	2.05	1.85	2.05	ns	
LVCMOS18_JEDEC, QUIETIO, 2 mA	1.01	1.19	6.09	6.29	6.09	6.29	ns	
LVCMOS18_JEDEC, QUIETIO, 4 mA	1.01	1.19	4.89	5.09	4.89	5.09	ns	
LVCMOS18_JEDEC, QUIETIO, 6 mA	1.01	1.19	4.20	4.40	4.20	4.40	ns	
LVCMOS18_JEDEC, QUIETIO, 8 mA	1.01	1.19	3.87	4.07	3.87	4.07	ns	
LVCMOS18_JEDEC, QUIETIO, 12 mA	1.01	1.19	3.49	3.69	3.49	3.69	ns	
LVCMOS18_JEDEC, QUIETIO, 16 mA	1.01	1.19	3.34	3.54	3.34	3.54	ns	
LVCMOS18_JEDEC, QUIETIO, 24 mA	1.01	1.19	3.17	3.37	3.17	3.37	ns	
LVCMOS18_JEDEC, Slow, 2 mA	1.01	1.19	4.79	4.99	4.79	4.99	ns	
LVCMOS18_JEDEC, Slow, 4 mA	1.01	1.19	3.84	4.04	3.84	4.04	ns	
LVCMOS18_JEDEC, Slow, 6 mA	1.01	1.19	3.18	3.38	3.18	3.38	ns	
LVCMOS18_JEDEC, Slow, 8 mA	1.01	1.19	2.37	2.57	2.37	2.57	ns	
LVCMOS18_JEDEC, Slow, 12 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns	
LVCMOS18_JEDEC, Slow, 16 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns	
LVCMOS18_JEDEC, Slow, 24 mA	1.01	1.19	2.13	2.33	2.13	2.33	ns	
LVCMOS18_JEDEC, Fast, 2 mA	1.01	1.19	3.75	3.95	3.75	3.95	ns	
LVCMOS18_JEDEC, Fast, 4 mA	1.01	1.19	2.54	2.74	2.54	2.74	ns	
LVCMOS18_JEDEC, Fast, 6 mA	1.01	1.19	2.02	2.22	2.02	2.22	ns	
LVCMOS18_JEDEC, Fast, 8 mA	1.01	1.19	1.94	2.14	1.94	2.14	ns	
LVCMOS18_JEDEC, Fast, 12 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns	
LVCMOS18_JEDEC, Fast, 16 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns	
LVCMOS18_JEDEC, Fast, 24 mA	1.01	1.19	1.86	2.06	1.86	2.06	ns	

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOP1</sub>		T <sub>IOP0</sub>		T <sub>IOTP</sub>		Units	
	Speed Grade		Speed Grade		Speed Grade			
	-3	-2	-3	-2	-3	-2		
LVCMOS15, QUIETIO, 2 mA	1.05	1.23	5.63	5.83	5.63	5.83	ns	
LVCMOS15, QUIETIO, 4 mA	1.05	1.23	4.75	4.95	4.75	4.95	ns	
LVCMOS15, QUIETIO, 6 mA	1.05	1.23	4.21	4.41	4.21	4.41	ns	
LVCMOS15, QUIETIO, 8 mA	1.05	1.23	4.05	4.25	4.05	4.25	ns	
LVCMOS15, QUIETIO, 12 mA	1.05	1.23	3.74	3.94	3.74	3.94	ns	
LVCMOS15, QUIETIO, 16 mA	1.05	1.23	3.52	3.72	3.52	3.72	ns	
LVCMOS15, Slow, 2 mA	1.05	1.23	4.32	4.52	4.32	4.52	ns	
LVCMOS15, Slow, 4 mA	1.05	1.23	3.58	3.78	3.58	3.78	ns	
LVCMOS15, Slow, 6 mA	1.05	1.23	2.45	2.65	2.45	2.65	ns	
LVCMOS15, Slow, 8 mA	1.05	1.23	2.46	2.66	2.46	2.66	ns	
LVCMOS15, Slow, 12 mA	1.05	1.23	2.17	2.37	2.17	2.37	ns	
LVCMOS15, Slow, 16 mA	1.05	1.23	2.15	2.35	2.15	2.35	ns	
LVCMOS15, Fast, 2 mA	1.05	1.23	3.43	3.63	3.43	3.63	ns	
LVCMOS15, Fast, 4 mA	1.05	1.23	2.42	2.62	2.42	2.62	ns	
LVCMOS15, Fast, 6 mA	1.05	1.23	1.92	2.12	1.92	2.12	ns	
LVCMOS15, Fast, 8 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15, Fast, 12 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15, Fast, 16 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, QUIETIO, 2 mA	1.10	1.28	5.64	5.84	5.64	5.84	ns	
LVCMOS15_JEDEC, QUIETIO, 4 mA	1.10	1.28	4.75	4.95	4.75	4.95	ns	
LVCMOS15_JEDEC, QUIETIO, 6 mA	1.10	1.28	4.21	4.41	4.21	4.41	ns	
LVCMOS15_JEDEC, QUIETIO, 8 mA	1.10	1.28	4.06	4.26	4.06	4.26	ns	
LVCMOS15_JEDEC, QUIETIO, 12 mA	1.10	1.28	3.75	3.95	3.75	3.95	ns	
LVCMOS15_JEDEC, QUIETIO, 16 mA	1.10	1.28	3.53	3.73	3.53	3.73	ns	
LVCMOS15_JEDEC, Slow, 2 mA	1.10	1.28	4.32	4.52	4.32	4.52	ns	
LVCMOS15_JEDEC, Slow, 4 mA	1.10	1.28	3.56	3.76	3.56	3.76	ns	
LVCMOS15_JEDEC, Slow, 6 mA	1.10	1.28	2.44	2.64	2.44	2.64	ns	
LVCMOS15_JEDEC, Slow, 8 mA	1.10	1.28	2.47	2.67	2.47	2.67	ns	
LVCMOS15_JEDEC, Slow, 12 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns	
LVCMOS15_JEDEC, Slow, 16 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns	
LVCMOS15_JEDEC, Fast, 2 mA	1.10	1.28	3.43	3.63	3.43	3.63	ns	
LVCMOS15_JEDEC, Fast, 4 mA	1.10	1.28	2.42	2.62	2.42	2.62	ns	
LVCMOS15_JEDEC, Fast, 6 mA	1.10	1.28	1.92	2.12	1.92	2.12	ns	
LVCMOS15_JEDEC, Fast, 8 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, Fast, 12 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, Fast, 16 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS12, QUIETIO, 2 mA	0.98	1.16	6.54	6.74	6.54	6.74	ns	
LVCMOS12, QUIETIO, 4 mA	0.98	1.16	5.12	5.32	5.12	5.32	ns	

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.2V	LVCMOS12, LVCMOS12_JEDEC	2	Fast	30 <sup>(1)</sup>	35	30	35
			Slow	51	55	51	52
			QuietIO	71	58	71	70
		4	Fast	17	17	17	19
			Slow	23	25	23	22
			QuietIO	35	32	35	32
		6	Fast	13	15	13	14
			Slow	19	20	19	17
			QuietIO	26	24	26	24
		8	Fast	N/A	12	N/A	12
			Slow	N/A	15	N/A	13
			QuietIO	N/A	20	N/A	19
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	11	N/A	10

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
2.5V	LVCMS25	2	Fast	38	43	38	43		
			Slow	46	52	46	48		
			QuietIO	57	64	57	59		
		4	Fast	21	24	21	23		
			Slow	26	31	26	27		
			QuietIO	33	32	33	30		
		6	Fast	15	17	15	16		
			Slow	19	22	19	19		
			QuietIO	25	23	25	19		
		8	Fast	12	15	12	14		
			Slow	15	18	15	16		
			QuietIO	21	19	21	16		
		12	Fast	1	3	1	1		
			Slow	2	7	2	4		
			QuietIO	3	8	3	8		
		16	Fast	1	3	1	1		
			Slow	3	7	3	3		
			QuietIO	4	9	4	8		
		24	Fast	N/A	3	N/A	1		
			Slow	N/A	5	N/A	2		
			QuietIO	N/A	8	N/A	6		
SSTL_2_I <sup>(3)</sup>				10	11	10	11		
SSTL_2_II <sup>(3)</sup>				N/A	7	N/A	7		
DIFF_SSTL_2_I <sup>(3)</sup>				30	33	30	33		
DIFF_SSTL_2_II <sup>(3)</sup>				N/A	21	N/A	24		

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
3.3V	LVCMOS33	2	Fast	42	46	42	44
			Slow	50	55	50	49
			QuietIO	60	68	60	60
		4	Fast	21	27	21	25
			Slow	32	37	32	32
			QuietIO	39	42	39	37
		6	Fast	14	19	14	17
			Slow	19	25	19	22
			QuietIO	29	30	29	25
		8	Fast	11	15	11	14
			Slow	15	20	15	18
			QuietIO	25	24	25	20
		12	Fast	1	3	1	1
			Slow	2	5	2	2
			QuietIO	4	9	4	7
		16	Fast	1	2	1	1
			Slow	1	5	1	1
			QuietIO	3	10	3	8
		24	Fast	1	2	1	1
			Slow	2	5	2	1
			QuietIO	7	9	7	7

Table 47: Configuration Switching Characteristics<sup>(1)</sup> (Cont'd)

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>BPI Master Flash Mode Programming Switching<sup>(4)</sup></b>						
T <sub>BPICCO</sub> <sup>(5)</sup>	A[25:0], FCS_B, FOE_B, FWE_B, LDC outputs valid after CCLK falling edge	15	15	15	20	ns, Max
T <sub>BPIICCK</sub>	Master BPI CCLK (output) delay	10/100	10/100	10/100	10/130	μs, Min/Max
T <sub>BPIDCC</sub> /T <sub>BPICCD</sub>	Setup/Hold on D[15:0] data input pins	5.0/1.0	5.0/1.0	5.0/1.0	6.0/2.0	ns, Min
<b>SPI Master Flash Mode Programming Switching<sup>(6)</sup></b>						
T <sub>SPIDCC</sub> /T <sub>SPIDCCD</sub>	DIN, MISO0, MISO1, MISO2, MISO3, Setup/Hold before/after the rising CCLK edge	5.0/1.0	5.0/1.0	5.0/1.0	7.0/1.0	ns, Min
T <sub>SPIIICCK</sub>	Master SPI CCLK (output) delay	0.4/7.0	0.4/7.0	0.4/7.0	0.4/10.0	μs, Min/Max
T <sub>SPICCM</sub>	MOSI clock to out	13	13	13	19	ns, Max
T <sub>SPICCF</sub>	CSO_B clock to out	16	16	16	26	ns, Max
<b>CCLK Output (Master Modes)</b>						
T <sub>MCCKL</sub>	Master CCLK clock duty cycle Low	40/60				%, Min/Max
T <sub>MCCKH</sub>	Master CCLK clock duty cycle High	40/60				%, Min/Max
F <sub>MCC</sub>	Maximum frequency, serial mode (Master Serial/SPI) All devices	40	40	40	30	MHz, Max
	Maximum frequency, parallel mode (Master SelectMAP/BPI) LX9, LX16, LX25, LX25T, LX45, LX45T, LX75, and LX75T	40	40	40	25	MHz, Max
	Maximum frequency, parallel mode (Master SelectMAP/BPI) LX100 and LX100T in x8 mode, LX150, and LX150T	40	40	40	20	MHz, Max
	Maximum frequency, parallel mode (Master SelectMAP/BPI) LX100 and LX100T in x16 mode	35	35	35	20	MHz, Max
F <sub>MCCKTOL</sub>	Frequency Tolerance, master mode	±50	±50	±50	±50	%
<b>CCLK Input (Slave Modes)</b>						
T <sub>SCCKL</sub>	Slave CCLK clock minimum Low time	5	5	5	8	ns, Min
T <sub>SCCKH</sub>	Slave CCLK clock minimum High time	5	5	5	8	ns, Min
<b>USERCCLK Input</b>						
T <sub>USERCCLKL</sub>	USERCCLK clock minimum Low time	12	12	12	16	ns, Min
T <sub>USERCCLKH</sub>	USERCCLK clock minimum High time	12	12	12	16	ns, Min
F <sub>USERCCLK</sub>	Maximum USERCCLK frequency	40	40	40	30	MHz, Max

**Notes:**

1. Maximum frequency and setup/hold timing parameters are for 3.3V and 2.5V configuration voltages.
2. To support longer delays in configuration, use the design solutions described in [UG380: Spartan-6 FPGA Configuration User Guide](#).
3. [Table 6](#) specifies the power supply ramp time.
4. BPI mode is not supported in:
  - LX4, LX25, or LX25T devices
  - LX9 devices in the TQG144 package
  - LX9 or LX16 devices in the CPG196 package.
5. Only during configuration, the last edge is determined by a weak pull-up/pull-down resistor in the I/O.
6. Defense-grade Spartan-6Q -2Q devices configure in single default SPI Master (x1) mode at  $T_j = -55^{\circ}\text{C}$ . During operation and when using all other configuration functions, the minimum operating temperature is  $-40^{\circ}\text{C}$ .

Table 52: PLL Specification (Cont'd)

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
$F_{INMIN}$	Minimum Input Clock Frequency	LX devices	19	19	19	19	MHz
		LXT devices	19	19	19	N/A	MHz
$F_{INJITTER}$	Maximum Input Clock Period Jitter: 19–200 MHz	All	1 ns Maximum				
	Maximum Input Clock Period Jitter: > 200 MHz	All	<20% of clock input period Maximum				
$F_{INDUTY}$	Allowable Input Duty Cycle: 19—199 MHz	All	25/75				%
	Allowable Input Duty Cycle: 200—299 MHz	All	35/65				%
	Allowable Input Duty Cycle: > 300 MHz	All	45/55				%
$F_{VCOMIN}$	Minimum PLL VCO Frequency	LX devices	400	400	400	400	MHz
		LXT devices	400	400	400	N/A	MHz
$F_{VCOMAX}$	Maximum PLL VCO Frequency	LX devices	1080	1050	1000	1000	MHz
		LXT devices	1080	1050	1000	N/A	MHz
$F_{BANDWIDTH}$	Low PLL Bandwidth at Typical <sup>(3)</sup>	All	1	1	1	1	MHz
	High PLL Bandwidth at Typical <sup>(3)</sup>	All	4	4	4	4	MHz
$T_{STAPHAOFFSET}$	Static Phase Offset of the PLL Outputs	All	0.12	0.12	0.12	0.15	ns
$T_{OUTJITTER}$	PLL Output Jitter <sup>(3)</sup>	All	Note 2				
$T_{OUTDUTY}$	PLL Output Clock Duty Cycle Precision <sup>(4)</sup>	All	0.15	0.15	0.20	0.25	ns
$T_{LOCKMAX}$	PLL Maximum Lock Time	All	100	100	100	100	μs
$F_{OUTMAX}$	PLL Maximum Output Frequency for BUFGMUX	LX devices	400	400	375	250	MHz
		LXT devices	400	400	375	N/A	MHz
	PLL Maximum Output Frequency for BUFPLL	LX devices	1080	1050	950	500	MHz
		LXT devices	1080	1050	950	N/A	MHz
$F_{OUTMIN}$	PLL Minimum Output Frequency <sup>(5)</sup>	All	3.125	3.125	3.125	3.125	MHz
$T_{EXTFDVAR}$	External Clock Feedback Variation: 19–200 MHz	All	1 ns Maximum				
	External Clock Feedback Variation: > 200 MHz	All	< 20% of clock input period Maximum				
$RST_{MINPULSE}$	Minimum Reset Pulse Width	All	5	5	5	5	ns
$F_{PFDMAX}^{(5)}$	Maximum Frequency at the Phase Frequency Detector	LX devices	500	500	400	300	MHz
		LXT devices	500	500	400	N/A	MHz
$F_{PFDMIN}$	Minimum Frequency at the Phase Frequency Detector	LX devices	19	19	19	19	MHz
		LXT devices	19	19	19	N/A	MHz
$T_{FBDELAY}$	Maximum Delay in the Feedback Path	All	3 ns Max or one CLKIN cycle				

**Notes:**

1. LXT devices are not available with a -1L speed grade.
2. Values for this parameter are available in the Clocking Wizard.
3. The PLL does not filter typical spread spectrum input clocks because they are usually far below the bandwidth filter frequencies.
4. Includes global clock buffer.
5. Calculated as  $F_{VCO}/128$  assuming output duty cycle is 50%.
6. When using CLK\_FEEDBACK = CLKOUT0 with BUFI02 feedback, the feedback frequency will be higher than the phase frequency detector frequency.  $F_{PFDMAX} = F_{CLKFB} / CLKFBOUT_MULT$

Table 57: Switching Characteristics for the Digital Frequency Synthesizer DFS (DCM\_CLKGEN)<sup>(1)</sup>

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Output Frequency Ranges (DCM_CLKGEN)</b>											
CLKOUT_FREQ_FX	Frequency for the CLKFX and CLKFX180 outputs	5	375	5	375	5	333	5	200	MHz	
CLKOUT_FREQ_FXDV	Frequency for the CLKFXDV output	0.15625	187.5	0.15625	187.5	0.15625	166.5	0.15625	100	MHz	
<b>Output Clock Jitter<sup>(2)(3)</sup></b>											
CLKOUT_PER_JITT_FX	Period jitter at the CLKFX and CLKFX180 outputs.	Typical = ±[0.2% of CLKFX period + 100]								ps	
CLKOUT_PER_JITT_FXDV	Period jitter at the CLKFXDV output.	Typical = ±[0.2% of CLKFX period + 100]								ps	
CLKFX_FREEZE_VAR	CLKFX period change in free running oscillator mode at the same temperature. FCLKFX > 50 MHz	Maximum = ±3% of CLKFX period								ps	
	CLKFX period change in free running oscillator mode at the same temperature. FCLKFX < 50 MHz	Maximum = ±5% of CLKFX period								ps	
CLKFX_FREEZE_TEMP_SLOPE	CLKFX period will change in free oscillator mode over temperature. Add to CLKFX_FREEZE_VAR to determine total CLKFX period change. Percentage change for CLKFX period over 1°C.	Maximum = 0.1								%/°C	
<b>Duty Cycle<sup>(4)(5)</sup></b>											
CLKOUT_DUTY_CYCLE_FX	Duty cycle precision for the CLKFX and CLKFX180 outputs, including the BUFGMUX and clock tree duty-cycle distortion	Maximum = ±[1% of CLKFX period + 350]								ps	
CLKOUT_DUTY_CYCLE_FXDV	Duty cycle precision for the CLKFXDV outputs, including the BUFGMUX and clock tree duty-cycle distortion	Maximum = ±[1% of CLKFX period + 350]								ps	
<b>Lock Time</b>											
LOCK_FX <sup>(2)</sup>	The time from deassertion at the DCM's Reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX, CLKFX180, and CLKFXDV signals are valid. Lock time requires CLKFX_DIVIDE < F <sub>IN</sub> /(0.50 MHz) when: F <sub>CLKIN</sub> < 50 MHz	–	50	–	50	–	50	–	50	ms	
	when: F <sub>CLKIN</sub> > 50 MHz	–	5	–	5	–	5	–	5	ms	

Table 64: Global Clock Input to Output Delay With DCM in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode.							
TICKOFDCM	Global Clock and OUTFF <i>with</i> DCM	XC6SLX4	4.23	N/A	6.11	6.60	ns
		XC6SLX9	4.23	5.17	6.11	6.60	ns
		XC6SLX16	4.28	4.57	5.34	6.36	ns
		XC6SLX25	3.95	4.18	4.59	6.91	ns
		XC6SLX25T	3.95	4.18	4.59	N/A	ns
		XC6SLX45	4.37	4.70	5.50	6.85	ns
		XC6SLX45T	4.37	4.70	5.50	N/A	ns
		XC6SLX75	3.90	4.23	4.77	6.31	ns
		XC6SLX75T	3.90	4.23	4.77	N/A	ns
		XC6SLX100	3.86	4.16	4.66	7.25	ns
		XC6SLX100T	3.90	4.16	4.66	N/A	ns
		XC6SLX150	4.03	4.33	4.83	6.63	ns
		XC6SLX150T	4.03	4.33	4.83	N/A	ns
		XA6SLX4	4.55	N/A	6.11	N/A	ns
		XA6SLX9	4.55	N/A	6.11	N/A	ns
		XA6SLX16	4.62	N/A	5.33	N/A	ns
		XA6SLX25	4.27	N/A	4.59	N/A	ns
		XA6SLX25T	4.27	N/A	4.69	N/A	ns
		XA6SLX45	4.69	N/A	5.50	N/A	ns
		XA6SLX45T	4.69	N/A	5.50	N/A	ns
		XA6SLX75	4.22	N/A	4.77	N/A	ns
		XA6SLX75T	4.22	N/A	4.77	N/A	ns
		XA6SLX100	N/A	N/A	5.34	N/A	ns
		XQ6SLX75	N/A	N/A	4.77	6.31	ns
		XQ6SLX75T	4.22	N/A	4.77	N/A	ns
		XQ6SLX150	N/A	N/A	4.96	6.63	ns
		XQ6SLX150T	4.62	N/A	4.96	N/A	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 68: Global Clock Input to Output Delay With DCM and PLL in System-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode and PLL in DCM2PLL Mode.							
$T_{ICKOFDCM\_PLL}$	Global Clock and OUTFF with DCM and PLL	XC6SLX4	4.78	N/A	6.32	7.09	ns
		XC6SLX9	4.78	5.24	6.32	7.09	ns
		XC6SLX16	4.70	5.12	5.94	6.63	ns
		XC6SLX25	4.70	5.09	5.92	7.30	ns
		XC6SLX25T	4.70	5.09	5.92	N/A	ns
		XC6SLX45	4.63	4.98	5.83	7.26	ns
		XC6SLX45T	4.63	4.98	5.83	N/A	ns
		XC6SLX75	4.68	5.04	5.88	6.90	ns
		XC6SLX75T	4.68	5.04	5.88	N/A	ns
		XC6SLX100	4.72	5.07	5.92	7.77	ns
		XC6SLX100T	4.76	5.07	5.92	N/A	ns
		XC6SLX150	4.44	4.73	5.31	6.96	ns
		XC6SLX150T	4.44	4.73	5.31	N/A	ns
		XA6SLX4	5.07	N/A	6.18	N/A	ns
		XA6SLX9	5.07	N/A	6.18	N/A	ns
		XA6SLX16	5.22	N/A	5.77	N/A	ns
		XA6SLX25	5.01	N/A	5.80	N/A	ns
		XA6SLX25T	5.01	N/A	5.90	N/A	ns
		XA6SLX45	4.93	N/A	5.67	N/A	ns
		XA6SLX45T	4.93	N/A	5.67	N/A	ns
		XA6SLX75	4.94	N/A	5.70	N/A	ns
		XA6SLX75T	4.94	N/A	5.70	N/A	ns
		XA6SLX100	N/A	N/A	5.77	N/A	ns
		XQ6SLX75	N/A	N/A	5.70	6.90	ns
		XQ6SLX75T	4.94	N/A	5.70	N/A	ns
		XQ6SLX150	N/A	N/A	5.31	6.96	ns
		XQ6SLX150T	5.02	N/A	5.31	N/A	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 71: Global Clock Setup and Hold Without DCM or PLL (Default Delay)

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.<sup>(1)</sup></b>							
T <sub>PSFD</sub> / T <sub>PHFD</sub>	Default Delay <sup>(2)</sup> Global Clock and IFF <sup>(3)</sup> without DCM or PLL	XC6SLX4	0.66/1.17	N/A	1.05/0.79	2.09/1.05	ns
		XC6SLX9	0.66/1.17	0.75/1.17	1.05/1.17	2.09/1.05	ns
		XC6SLX16	0.87/1.16	0.93/1.16	0.96/1.16	1.86/1.06	ns
		XC6SLX25	0.68/0.77	0.81/0.81	0.87/0.82	2.21/1.33	ns
		XC6SLX25T	0.68/0.77	0.81/0.81	0.87/0.82	N/A	ns
		XC6SLX45	0.40/1.05	0.42/1.17	0.64/1.20	1.61/1.67	ns
		XC6SLX45T	0.40/1.05	0.42/1.17	0.64/1.20	N/A	ns
		XC6SLX75	0.41/1.11	0.41/1.13	0.80/1.14	1.23/1.82	ns
		XC6SLX75T	0.41/1.11	0.41/1.13	0.80/1.14	N/A	ns
		XC6SLX100	0.39/1.12	0.39/1.23	0.39/1.28	1.13/1.94	ns
		XC6SLX100T	0.39/1.12	0.39/1.23	0.39/1.28	N/A	ns
		XC6SLX150	0.23/1.54	0.23/1.62	0.23/1.62	1.14/2.05	ns
		XC6SLX150T	0.23/1.54	0.23/1.62	0.23/1.62	N/A	ns
		XA6SLX4	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX9	0.73/1.18	N/A	1.05/0.80	N/A	ns
		XA6SLX16	0.90/1.20	N/A	0.96/0.75	N/A	ns
		XA6SLX25	0.70/0.81	N/A	0.87/0.91	N/A	ns
		XA6SLX25T	0.76/0.81	N/A	1.03/0.91	N/A	ns
		XA6SLX45	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX45T	0.40/1.06	N/A	0.64/1.20	N/A	ns
		XA6SLX75	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XA6SLX100	N/A	N/A	0.86/1.55	N/A	ns
		XQ6SLX75	N/A	N/A	0.80/1.18	1.23/1.82	ns
		XQ6SLX75T	0.41/1.24	N/A	0.80/1.18	N/A	ns
		XQ6SLX150	N/A	N/A	0.28/1.57	1.14/2.05	ns
		XQ6SLX150T	0.28/1.78	N/A	0.28/1.57	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. Default delay uses IODELAY2 tap 0.
3. IFF = Input Flip-Flop or Latch.

Table 73: Global Clock Setup and Hold With DCM in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
<b>Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.<sup>(1)</sup></b>							
T <sub>PSDCM0</sub> / T <sub>PHDCM0</sub>	No Delay Global Clock and IFF <sup>(2)</sup> with DCM in Source-Synchronous Mode	XC6SLX4	0.71/0.65	N/A	0.72/1.22	1.58/1.18	ns
		XC6SLX9	0.71/0.69	0.71/1.19	0.72/1.36	1.58/1.18	ns
		XC6SLX16	0.86/0.52	0.92/0.57	1.04/0.60	1.02/1.06	ns
		XC6SLX25	0.84/0.58	0.90/0.59	1.01/0.59	1.58/1.07	ns
		XC6SLX25T	0.84/0.58	0.90/0.59	1.01/0.59	N/A	ns
		XC6SLX45	0.85/0.70	0.90/0.76	0.98/0.79	1.34/1.34	ns
		XC6SLX45T	0.85/0.70	0.90/0.76	0.98/0.79	N/A	ns
		XC6SLX75	1.00/0.62	1.06/0.63	1.15/0.63	1.65/1.46	ns
		XC6SLX75T	1.00/0.71	1.06/0.72	1.15/0.72	N/A	ns
		XC6SLX100	0.81/0.68	0.81/0.69	0.94/0.69	1.42/2.07	ns
		XC6SLX100T	0.81/0.68	0.81/0.69	0.94/0.69	N/A	ns
		XC6SLX150	0.68/0.98	0.69/0.99	0.79/0.99	1.45/1.60	ns
		XC6SLX150T	0.68/0.98	0.69/0.99	0.79/0.99	N/A	ns
		XA6SLX4	0.81/0.74	N/A	0.72/1.36	N/A	ns
		XA6SLX9	0.81/0.74	N/A	0.72/1.36	N/A	ns
		XA6SLX16	1.01/0.56	N/A	1.04/0.60	N/A	ns
		XA6SLX25	0.94/0.76	N/A	1.06/0.77	N/A	ns
		XA6SLX25T	0.94/0.76	N/A	1.14/0.77	N/A	ns
		XA6SLX45	0.86/0.74	N/A	0.98/0.78	N/A	ns
		XA6SLX45T	0.86/0.74	N/A	0.98/0.78	N/A	ns
		XA6SLX75	1.02/0.71	N/A	1.15/0.72	N/A	ns
		XA6SLX75T	1.02/0.71	N/A	1.15/0.72	N/A	ns
		XA6SLX100	N/A	N/A	1.37/0.75	N/A	ns
		XQ6SLX75	N/A	N/A	1.15/0.72	1.65/1.46	ns
		XQ6SLX75T	1.02/0.71	N/A	1.15/0.72	N/A	ns
		XQ6SLX150	N/A	N/A	0.79/1.15	1.45/1.60	ns
		XQ6SLX150T	0.73/1.15	N/A	0.79/1.15	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 77: Global Clock Setup and Hold With DCM and PLL in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
Example Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, <sup>(1)</sup> Using DCM, PLL, and Global Clock Buffer for the LVCMS25 standard.							
$T_{PSDCMPLL\_0'}$ $T_{PHDCMPLL\_0}$	No Delay Global Clock and IFF <sup>(2)</sup> with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode.	XC6SLX4	0.43/1.07	N/A	0.43/1.43	1.10/1.67	ns
		XC6SLX9	0.43/1.03	0.45/1.14	0.45/1.43	1.10/1.67	ns
		XC6SLX16	0.74/0.93	0.74/1.12	0.74/1.21	0.77/1.35	ns
		XC6SLX25	0.67/1.02	0.76/1.11	0.84/1.18	1.23/1.46	ns
		XC6SLX25T	0.67/1.02	0.76/1.11	0.84/1.18	N/A	ns
		XC6SLX45	0.65/0.99	0.65/1.04	0.71/1.12	1.18/1.58	ns
		XC6SLX45T	0.65/1.00	0.65/1.04	0.71/1.12	N/A	ns
		XC6SLX75	0.86/1.01	0.88/1.06	0.94/1.14	1.29/1.67	ns
		XC6SLX75T	0.86/1.01	0.88/1.06	0.94/1.14	N/A	ns
		XC6SLX100	0.50/1.10	0.56/1.10	0.61/1.17	0.84/2.24	ns
		XC6SLX100T	0.50/1.10	0.56/1.10	0.61/1.17	N/A	ns
		XC6SLX150	0.45/1.28	0.47/1.28	0.52/1.28	1.27/1.56	ns
		XC6SLX150T	0.45/1.28	0.47/1.28	0.52/1.28	N/A	ns
		XA6SLX4	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX9	0.74/1.00	N/A	0.74/1.43	N/A	ns
		XA6SLX16	1.81/1.15	N/A	1.81/1.03	N/A	ns
		XA6SLX25	0.89/1.01	N/A	0.96/1.05	N/A	ns
		XA6SLX25T	0.89/1.01	N/A	1.04/1.15	N/A	ns
		XA6SLX45	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX45T	0.69/0.95	N/A	0.83/0.96	N/A	ns
		XA6SLX75	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XA6SLX100	N/A	N/A	1.55/1.33	N/A	ns
		XQ6SLX75	N/A	N/A	1.06/0.96	1.29/1.67	ns
		XQ6SLX75T	0.88/0.94	N/A	1.06/0.96	N/A	ns
		XQ6SLX150	N/A	N/A	0.64/1.30	1.27/1.56	ns
		XQ6SLX150T	0.58/1.30	N/A	0.64/1.30	N/A	ns

**Notes:**

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. The timing values were measured using the fine-phase adjustment feature of the DCM. These measurements include CMT jitter; DCM CLK0 driving PLL, PLL CLKOUT0 driving BUFG. Package skew is not included in these measurements.
2. IFF = Input Flip-Flop

## Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Spartan-6 FPGA source-synchronous transmitter and receiver data-valid windows.

Table 78: Duty Cycle Distortion and Clock-Tree Skew

Symbol	Description	Device <sup>(1)</sup>	Speed Grade				Units
			-3	-3N	-2	-1L	
$T_{DCD\_CLK}$	Global Clock Tree Duty Cycle Distortion <sup>(2)</sup>	LX4	0.20	N/A	0.20	0.35	ns
		LX9	0.20	0.20	0.20	0.35	ns
		LX16	0.20	0.20	0.20	0.35	ns
		LX25	0.20	0.20	0.20	0.35	ns
		LX25T	0.20	0.20	0.20	N/A	ns
		LX45	0.20	0.20	0.20	0.35	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.20	0.20	0.20	0.35	ns
		LX75T	0.20	0.20	0.20	N/A	ns
		LX100	0.20	0.20	0.20	0.35	ns
		LX100T	0.20	0.20	0.20	N/A	ns
		LX150	0.35	0.35	0.35	0.35	ns
		LX150T	0.35	0.35	0.35	N/A	ns
$T_{CKSKEW}$	Global Clock Tree Skew <sup>(3)</sup>	LX4	0.25	N/A	0.25	0.29	ns
		LX9	0.25	0.25	0.25	0.29	ns
		LX16	0.15	0.15	0.15	0.22	ns
		LX25	0.26	0.26	0.26	0.41	ns
		LX25T	0.26	0.26	0.26	N/A	ns
		LX45	0.20	0.20	0.20	0.28	ns
		LX45T	0.20	0.20	0.20	N/A	ns
		LX75	0.56	0.56	0.56	0.50	ns
		LX75T	0.56	0.56	0.56	N/A	ns
		XC6SLX100 <sup>(4)</sup>	0.22	0.22	0.22	0.21	ns
		XA6SLX100 <sup>(4)</sup>	N/A	N/A	0.43	N/A	ns
		LX100T	0.22	0.22	0.22	N/A	ns
		LX150	0.48	0.48	0.48	0.35	ns
		LX150T	0.48	0.48	0.48	N/A	ns
$T_{DCD\_BUFIO2}$	I/O clock tree duty cycle distortion	LX devices	0.25	0.25	0.25	0.50	ns
		LXT devices	0.25	0.25	0.25	N/A	ns

Date	Version	Description of Revisions
09/14/11	2.4	<p>Production release of the XA6SLX4 and XA6SLX9 devices in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19. Added production released version of the XA6SLX100 to <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.3 software with -2 speed specification v1.20.</p> <p>Updated <math>R_{OUT\_TERM}</math> description in <a href="#">Table 4</a>. Fixed the LVPECL <math>V_H</math> error in <a href="#">Table 31</a>. Updated introduction in <a href="#">Simultaneously Switching Outputs</a>. Added the XA6SLX100 to <a href="#">Table 63</a> through <a href="#">Table 78</a>, and <a href="#">Table 81</a>. Added <a href="#">Note 4</a> to <a href="#">Table 78</a> because the <math>T_{CKSKEW}</math> for the XC6SLX100 is not the same as the <math>T_{CKSKEW}</math> for the XA6SLX100.</p> <p>Revised the revision history for version <a href="#">1.6</a> dated <a href="#">06/24/10</a>. Removed the parenthetical statement about the -3N speed grade: (specifications are identical to the -3 speed grade).</p>
10/17/11	3.0	<p>Changed the data sheet from Preliminary Product Specification to Product Specification.</p> <p>Updated the <a href="#">Switching Characteristics, page 19</a> speed specification version ISE v13.3 software to -2 and -3 speed specification v1.20 and -1L speed specification of v1.08. Also updated <a href="#">Note 1</a> in <a href="#">Table 27</a>.</p> <p>In <a href="#">Table 43, Block RAM Switching Characteristics</a>, the <math>F_{MAX}</math> value for the -2 speed grade has been changed from 260 MHz to 280 MHz.</p> <p>In <a href="#">Table 54, Switching Characteristics for the DLL</a>, a <a href="#">Note 6</a> was added and linked to CLKIN_CLKFB_PHASE.</p>